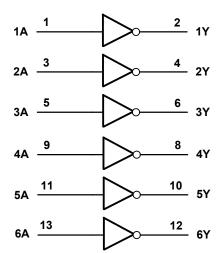


Pin Descriptions

Pin Number	Pin Name	Function
1	1A	Data Input
2	1Y	Data Output
3	2A	Data Input
4	2Y	Data Output
5	3A	Data Input
6	3Y	Data Output
7	GND	Ground
8	4Y	Data Output
9	4A	Data Input
10	5Y	Data Output
11	5A	Data Input
12	6Y	Data Output
13	6A	Data Input
14	Vcc	Supply Voltage

Logic Diagram



Function Table

Input	Output
Α	Y
L	Н
Н	L

Absolute Maximum Ratings (Note 4) (@T_A = +25°C, unless otherwise specified.)

Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	KV
ESD CDM	Charged Device Model ESD Protection	1	KV
ESD MM	Machine Model ESD Protection	200	V
V_{CC}	Supply Voltage Range	-0.5 to +7.0	V
Vı	Input Voltage Range	-0.5 to +7.0	V
I _{IK}	Input Clamp Current V _I < -0.5V	-20	mA
I _{OK}	Output Clamp Current V _O < -0.5V	-20	mA
I _{OK}	Output Clamp Current V _O > V _{CC} +0.5V	25	mA
lo	Continuous Output Current -0.5V < V _O V _{CC} +0.5V	+/- 25	mA
Icc	Continuous Current Through V _{CC}	75	mA
I _{GND}	Continuous Current Through GND	-75	mA
TJ	Operating Junction Temperature	-40 to +150	°C
T _{STG}	Storage Temperature	-65 to +150	°C
P _{TOT}	Total Power Dissipation	500	mW

Notes: 4. Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.



Recommended Operating Conditions (Note 5) (@T_A = +25°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Max	Unit
Vcc	Supply Voltage		2.0	5.5	V
VI	Input Voltage		0	5.5	V
Vo	Output Voltage		0	V _{CC}	V
Δt/ΔV	Input Transition Rise or Fall Rate	V _{CC} = 3.0V to 3.6V		100	ns/V
ΔυΔν	input transition Rise of Fall Rate	V _{CC} = 4.5V to 5.5V		20	115/ V
T _A	Operating Free-Air Temperature		-40	+125	°C

^{5.} Unused inputs should be held at V_{CC} or Ground.

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Symphol	Parameter	Test Conditions	V	T _A = -40°	C to +85°C	T _A = -40°C	to +125°C	Unit
Symbol	Parameter	rest Conditions	V _{CC}	Min	Max	Min	Max	Unit
			2.0V	1.5		1.5		
V_{IH}	High-Level Input Voltage		3.0V	2.1		2.1		V
	Voltage		5.5V	3.85		3.85		
			2.0V		0.5		0.5	
V_{IL}	Low-Level Input Voltage		3.0V		0.9		0.9	V
	Voltage		5.5V		1.65		1.65	
	V _{OH} High-Level Output Voltage	I _{OH} = -50μA	2.0V	1.9		1.9		
		I _{OH} = -50μA	3.0V	2.9		2.9		V
V_{OH}		I _{OH} = -50μA	4.5V	4.4		4.4		
	Voltage	I _{OH} = -4mA	3.0V	2.48		2.40		
		I _{OH} = -8mA	4.5V	3.80		3.70		
		I _{OL} = 50μA	2.0V		0.1		0.1	
		I _{OL} = 50μA	3.0V		0.1		0.1	
V_{OL}	Low-Level Output Voltage	I _{OL} = 50μA	4.5V		0.1		0.1	V
	Voltage	I _{OL} = 4mA	3.0V		0.44		0.55	
	I _{OL} = 8mA	4.5V		0.44		0.55		
II	Input Current	V _I =GND to 5.5V	3.6V		±1		±2	μΑ
Icc	Supply Current	$V_I = GND \text{ or } V_{CC}, I_O=0$	3.6V		20		40	μΑ

Operating Characteristics

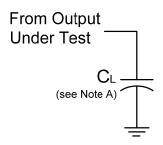
	Parameter		V _{CC} = 2.0V	V _{CC} = 3.3V	V _{CC} = 5V	Unit
		Conditions	Тур	Тур	Тур	Ollit
C _{pd}	Power Dissipation Capacitance per Gate	f = 1MHz	9.7	11.2	15	pF
C _i	Input Capacitance	$V_i = V_{CC} - or$ GND	4.0	4.0	4.0	pF



Switching Characteristics

Symbol	Parameter	Test	V	Т	A = +25°	С	-40°C to	+85°C	-40°C to	+125°C	Unit
Symbol	Parameter	Conditions	V _{CC}	Min	Тур	Max	Min	Max	Min	Max	Onne
		Figure 1	3.0V to 3.6V	0.5	4.0	8.5	0.5	10.5	0.5	11.0	
Propagation	$C_L = 15pF$	4.5V to 5.5V	0.5	3.0	5.5	0.5	6.5	0.5	7.0]	
ŀРD	t _{PD} Delay A _N to Y _N	Figure 1	3.0V to 3.6V	0.5	6.0	11.4	0.5	13.0	0.5	14.5	ns
		$C_L = 50pF$	4.5V to 5.5V	0.5	4.5	7.5	0.5	8.5	0.5	9.5]

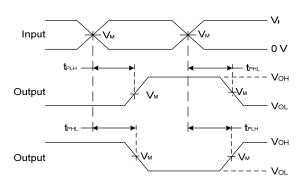
Parameter Measurement Information



V	Inj	outs	v	
V _{CC}	VI	t _r /t _f	V _M	C _L
3.3V -3.6V	V _{CC}	3ns	V _{CC} /2	15pF, 50pF
4.5V to 5.5V	V _{CC}	3ns	V _{CC} /2	15pF, 50pF



Voltage Waveform Pulse Duration



Voltage Waveform Propagation Delay Times Inverting and Non Inverting Outputs

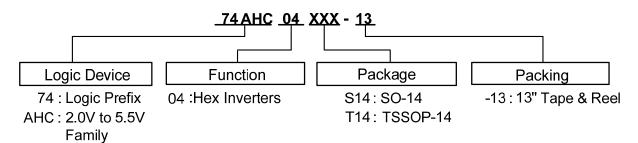
Figure 1 Load Circuit and Voltage Waveforms

Notes: A . Includes test lead and test apparatus capacitance.

- B. All pulses are supplied at pulse repetition rate ≤ 1 MHz.
- C. Inputs are measured separately one transition per measurement.
- D. t_{PLH} and t_{PHL} are the same as $t_{\text{PD.}}$



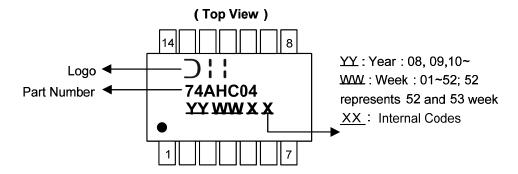
Ordering Information



	Device	Package Code	Dockoning	7" Tape a	and Reel
	Device	Package Code	Packaging	Quantity	Part Number Suffix
free Green	74AHC04S14-13	S14	SO-14	2500/Tape & Reel	-13
free Green	74AHC04T14-13	T14	TSSOP-14	2500/Tape & Reel	-13

Marking Information

(1) SO-14, TSSOP-14



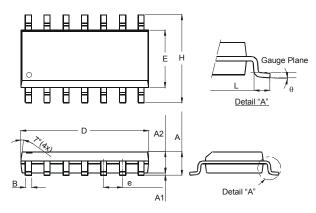
Part Number	Package
74AHC04S14	SO-14
74AHC04T14	TSSOP-14



Package Outline Dimensions (All dimensions in mm.)

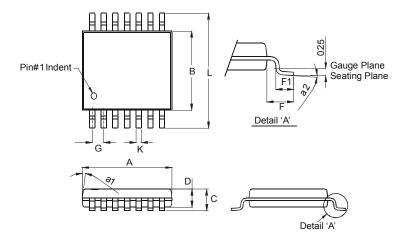
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.

Package Type: SO-14



	SO-14	
Dim	Min	Max
Α	1.47	1.73
A1	0.10	0.25
A2	1.45	Тур
В	0.33	0.51
D	8.53	8.74
Е	3.80	3.99
е	1.27	Тур
Н	5.80	6.20
L	0.38	1.27
θ	0°	8°
All Di	mensions	s in mm

Package Type: TSSOP-14



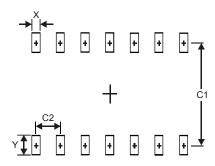
	TSSOP-14					
Dim	Min	Max				
a1	7° (4X)				
a2	0°	8°				
Α	4.9	5.10				
В	4.30	4.50				
С		1.2				
D	8.0	1.05				
F	1.00	Тур				
F1	0.45	0.75				
G	0.65	Тур				
K	0.19	0.30				
L 6.40 Typ						
All Dimensions in mm						



Suggested Pad Layout

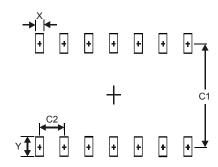
Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

Package Type: SO-14



Dimensions	Value (in mm)
Х	0.60
Υ	1.50
C1	5.4
C2	1.27

Package Type: TSSOP-14



Dimensions	Value (in mm)
X	0.45
Υ	1.45
C1	5.9
C2	0.65



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